

Photocouplers Photorelay

# TLP220AF

#### 1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment
- Smart Meters
- Electricity Meters

#### 2. General

The TLP220AF photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 4-pin DIP package. It provides an isolation voltage of 5000 Vrms, making it suitable for applications that require reinforced insulation.

#### 3. Features

- (1) Normally open (1-Form-A)
- (2) OFF-state output terminal voltage: 60 V (min)
- (3) Trigger LED current: 2 mA (max)
- (4) ON-state current: 500 mA (max)
- (5) ON-state resistance:  $2 \Omega$  (max)
- (6) Isolation voltage: 5000 Vrms (min)
- (7) Safety standards

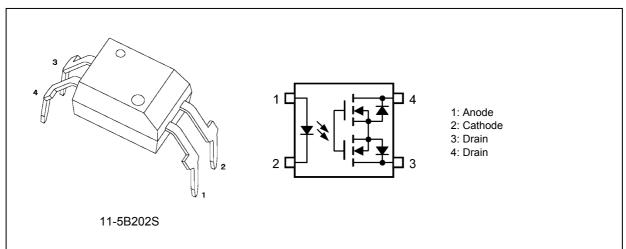
UL-approved: UL1577 File No. E67349

cUL-approved: CSA Component Acceptance Service No. 5A, File No. E67349

VDE-approved: Option (D4) EN60747-5-5 (Note)

Note: When an EN60747-5-5 approved type is needed, please designate the Option (D4)

#### 4. Packaging and Pin Assignment



### 5. Internal Circuit

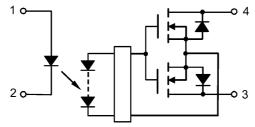


Fig. 5.1 Internal Circuit

#### 6. Mechanical Parameters

| Characteristics              | 7.62-mm Pitch<br>TLP220A | 10.16-mm Pitch<br>TLP220AF | Unit |
|------------------------------|--------------------------|----------------------------|------|
| Creepage distances           | 7.0 (min)                | 8.0 (min)                  | mm   |
| Clearance distances          | 7.0 (min)                | 8.0 (min)                  |      |
| Internal isolation thickness | 0.4 (min)                | 0.4 (min)                  |      |

### 7. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25^{\circ}C$ )

|          | Characteristics                   |                           | Symbol                       | Note     | Rating     | Unit  |
|----------|-----------------------------------|---------------------------|------------------------------|----------|------------|-------|
| LED      | Input forward current             |                           | I <sub>F</sub>               |          | 30         | mA    |
|          | Input forward current derating    | $(T_a \ge 25^{\circ}C)$   | $\Delta I_F / \Delta T_a$    |          | -0.3       | mA/°C |
|          | Input forward current (pulsed)    | (100 µs pulse, 100 pps)   | I <sub>FP</sub>              |          | 1          | A     |
|          | Input reverse voltage             |                           | V <sub>R</sub>               |          | 5          | V     |
|          | Input power dissipation           | _                         | PD                           |          | 50         | mW    |
|          | Junction temperature              |                           | Tj                           |          | 125        | °C    |
| Detector | OFF-state output terminal voltage |                           | V <sub>OFF</sub>             |          | 60         | V     |
|          | ON-state current                  |                           | I <sub>ON</sub>              |          | 500        | mA    |
|          | ON-state current derating         | $(T_a \ge 25^{\circ}C)$   | $\Delta I_{ON} / \Delta T_a$ |          | -5         | mA/°C |
|          | ON-state current (pulsed)         | (t = 100 ms, Duty = 1/10) | I <sub>ONP</sub>             |          | 1.5        | А     |
|          | Output power dissipation          |                           | Po                           |          | 500        | mW    |
|          | Junction temperature              |                           | Тj                           |          | 125        | °C    |
| Common   | Storage temperature               |                           | T <sub>stg</sub>             |          | -55 to 125 |       |
|          | Operating temperature             |                           | T <sub>opr</sub>             |          | -40 to 85  |       |
|          | Lead soldering temperature        | (10 s)                    | T <sub>sol</sub>             |          | 260        |       |
|          | Isolation voltage                 | AC, 1 min, R.H. ≤ 60%     | BVS                          | (Note 1) | 5000       | Vrms  |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

#### 8. Recommended Operating Conditions (Note)

| Characteristics       | Symbol           | Note | Min | Тур. | Max | Unit |
|-----------------------|------------------|------|-----|------|-----|------|
| Supply voltage        | V <sub>DD</sub>  |      | —   | —    | 48  | V    |
| Input forward current | ١ <sub>F</sub>   |      | 3   | 5    | 15  | mA   |
| ON-state current      | I <sub>ON</sub>  |      | _   | _    | 500 |      |
| Operating temperature | T <sub>opr</sub> |      | -20 |      | 65  | C°   |

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

#### 9. Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$ )

|          | Characteristics       | Symbol           | Note | Test Condition          | Min  | Тур. | Max  | Unit |
|----------|-----------------------|------------------|------|-------------------------|------|------|------|------|
| LED      | Input forward voltage | V <sub>F</sub>   |      | I <sub>F</sub> = 10 mA  | 1.45 | 1.63 | 1.75 | V    |
|          | Input reverse current | I <sub>R</sub>   |      | V <sub>R</sub> = 5 V    | _    | _    | 10   | μA   |
|          | Input capacitance     | Ct               |      | V = 0 V, f = 1 MHz      | _    | 40   | _    | pF   |
| Detector | OFF-state current     | I <sub>OFF</sub> |      | V <sub>OFF</sub> = 60 V | _    | _    | 1    | μA   |
|          | Output capacitance    | C <sub>OFF</sub> |      | V = 0 V, f = 1 MHz      | _    | 130  |      | pF   |

#### 10. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}$ C)

| Characteristics     | Symbol          | Note     | Test Condition                                | Min | Тур. | Max | Unit |
|---------------------|-----------------|----------|---|-----|------|-----|------|
| Trigger LED current | I <sub>FT</sub> |          | I <sub>ON</sub> = 500 mA                      | _   | 0.3  | 2   | mA   |
| Return LED current  | I <sub>FC</sub> |          | I <sub>OFF</sub> = 10 μA                      | 0.1 | _    | —   | mA   |
| ON-state resistance | R <sub>ON</sub> | (Note 1) | $I_{ON}$ = 500 mA, $I_{F}$ = 5 mA, Continuous | _   | 0.6  | 2   | Ω    |

Note 1: Thermally saturated state.

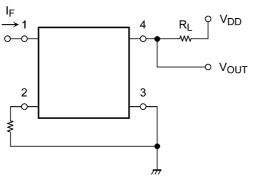
#### 11. Isolation Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$ )

| Characteristics                     | Symbol         | Note     | Test Condition                  | Min                  | Тур.             | Max | Unit |
|-------------------------------------|----------------|----------|---------------------------------|----------------------|------------------|-----|------|
| Total capacitance (input to output) | Cs             | (Note 1) | V <sub>S</sub> = 0 V, f = 1 MHz | _                    | 0.8              | —   | pF   |
| Isolation resistance                | R <sub>S</sub> | (Note 1) | $V_S$ = 500 V, R.H. $\leq 60\%$ | 1 × 10 <sup>12</sup> | 10 <sup>14</sup> | _   | Ω    |
| Isolation voltage                   | BVS            | (Note 1) | AC, 1 min                       | 5000                 |                  | —   | Vrms |
|                                     |                |          | AC, 1s in oil                   | _                    | 10000            | —   |      |
|                                     |                |          | DC, 1 min, in oil               | _                    | 10000            | _   | Vdc  |

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

### 12. Switching Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$ )

| Characteristics | Symbol           | Note | Test Condition  | Min | Тур | Max | Unit |
|-----------------|------------------|------|---|-----|-----|-----|------|
| Turn-on time    | t <sub>ON</sub>  |      | See Fig. 12.1.  | _   | 0.5 | 1   | ms   |
| Turn-off time   | t <sub>OFF</sub> |      | R <sub>L</sub> = 200 Ω, V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA |     | 0.2 | 1   |      |



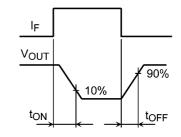
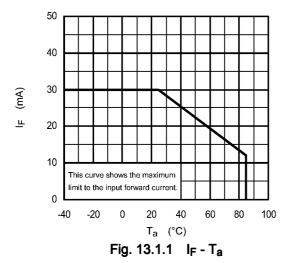
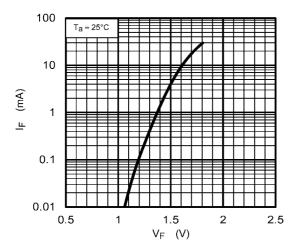


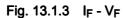
Fig. 12.1 Switching Time Test Circuit

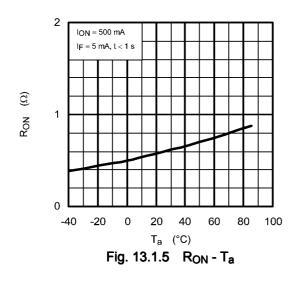
#### 13. Characteristics Curves

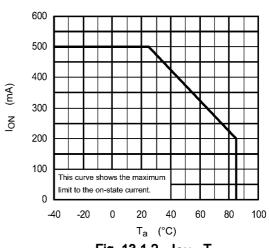
#### 13.1. Characteristics Curves (Note)

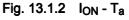












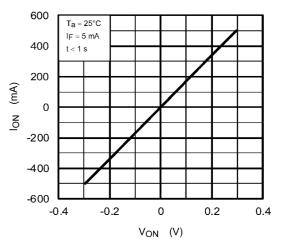
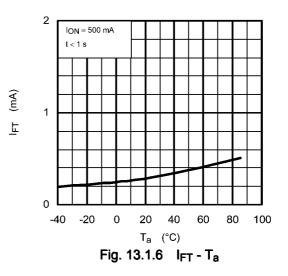
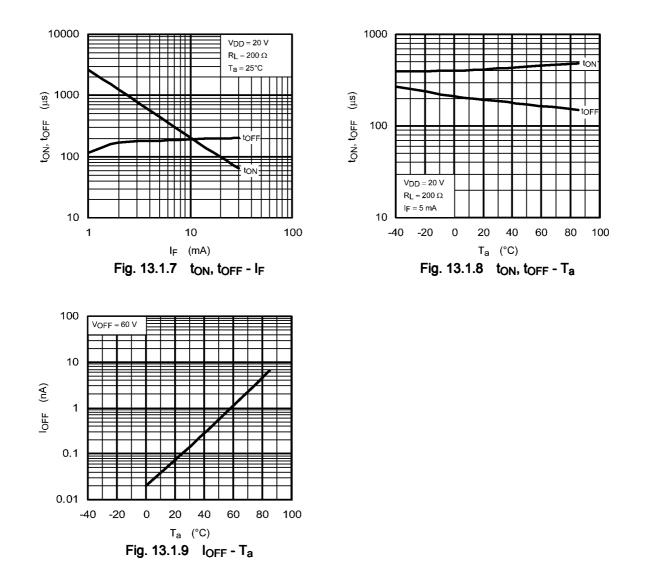


Fig. 13.1.4 I<sub>ON</sub> - V<sub>ON</sub>





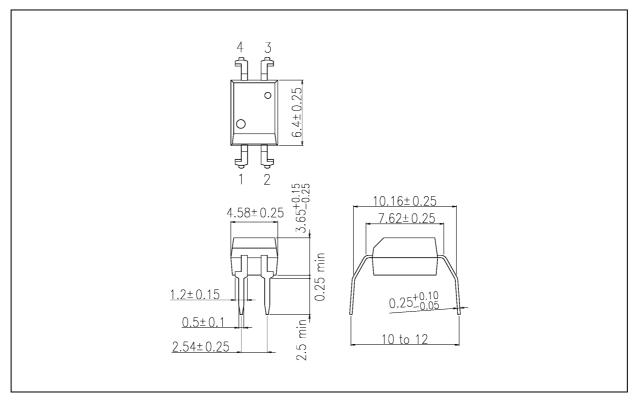
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



### TLP220AF

#### Package Dimensions

Unit: mm



Weight: 0.26 g (typ.)

|                    | Package Name(s) |
|--------------------|-----------------|
| TOSHIBA: 11-5B202S |                 |

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